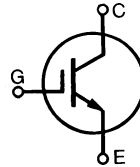


**Low  $V_{CE(sat)}$  IGBT**  
**High Speed IGBT**

**IXSH/IXSM 40 N60**  
**IXSH/IXSM 40 N60A**

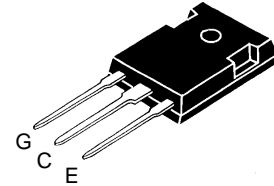
$V_{CES}$	$I_{C25}$	$V_{CE(sat)}$
600 V	75 A	2.5 V
600 V	75 A	3.0 V

**Short Circuit SOA Capability**

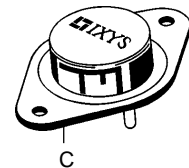


Symbol	Test Conditions	Maximum Ratings	
$V_{CES}$	$T_J = 25^\circ\text{C}$ to $150^\circ\text{C}$	600	V
$V_{CGR}$	$T_J = 25^\circ\text{C}$ to $150^\circ\text{C}$ ; $R_{GE} = 1\ \text{M}\Omega$	600	V
$V_{GES}$	Continuous	$\pm 20$	V
$V_{GEM}$	Transient	$\pm 30$	V
$I_{C25}$	$T_C = 25^\circ\text{C}$	75	A
$I_{C90}$	$T_C = 90^\circ\text{C}$	40	A
$I_{CM}$	$T_C = 25^\circ\text{C}$ , 1 ms	150	A
<b>SSOA (RBSOA)</b>	$V_{GE} = 15\ \text{V}$ , $T_J = 125^\circ\text{C}$ , $R_G = 2.7\ \Omega$ Clamped inductive load, $L = 30\ \mu\text{H}$	$I_{CM} = 80$ @ $0.8\ V_{CES}$	A
<b><math>t_{SC}</math> (SCSOA)</b>	$V_{GE} = 15\ \text{V}$ , $V_{CE} = 360\ \text{V}$ , $T_J = 125^\circ\text{C}$ $R_G = 22\ \Omega$ , non repetitive	10	$\mu\text{s}$
$P_c$	$T_C = 25^\circ\text{C}$	300	W
$T_J$		-55 ... +150	$^\circ\text{C}$
$T_{JM}$		150	$^\circ\text{C}$
$T_{stg}$		-55 ... +150	$^\circ\text{C}$
$M_d$	Mounting torque	1.13/10 Nm/lb.in.	
<b>Weight</b>		TO-204 = 18 g, TO-247 = 6g	
Maximum lead temperature for soldering 1.6 mm (0.062 in.) from case for 10 s		300	$^\circ\text{C}$

**TO-247 AD (IXSH)**



**TO-204 AE (IXSM)**



G = Gate, C = Collector,  
E = Emitter, TAB = Collector

**Features**

- International standard packages
- Guaranteed Short Circuit SOA capability
- Low  $V_{CE(sat)}$ 
  - for low on-state conduction losses
- High current handling capability
- MOS Gate turn-on
  - drive simplicity
- Fast Fall Time for switching speeds up to 20 kHz

**Applications**

- AC motor speed control
- Uninterruptible power supplies (UPS)
- Welding

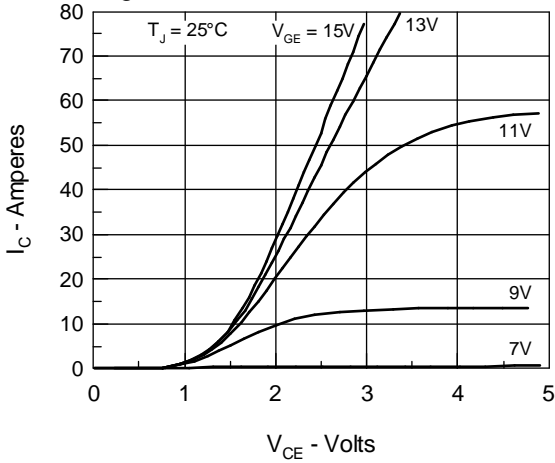
**Advantages**

- Easy to mount with 1 screw (TO-247) (isolated mounting screw hole)
- High power density

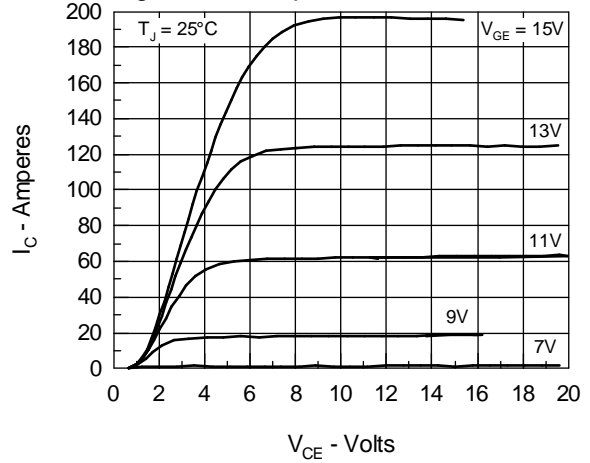
Symbol	Test Conditions	Characteristic Values ( $T_J = 25^\circ\text{C}$ , unless otherwise specified)		
		min.	typ.	max.
$BV_{CES}$	$I_C = 250\ \mu\text{A}$ , $V_{GE} = 0\ \text{V}$	600		V
$V_{GE(th)}$	$I_C = 4\ \text{mA}$ , $V_{CE} = V_{GE}$	4		7 V
$I_{CES}$	$V_{CE} = 0.8 \cdot V_{CES}$ , $T_J = 25^\circ\text{C}$ $V_{GE} = 0\ \text{V}$ , $T_J = 125^\circ\text{C}$			50 $\mu\text{A}$ 1 mA
$I_{GES}$	$V_{CE} = 0\ \text{V}$ , $V_{GE} = \pm 20\ \text{V}$			$\pm 100\ \text{nA}$
$V_{CE(sat)}$	$I_C = I_{C90}$ , $V_{GE} = 15\ \text{V}$	40N60 40N60A		2.5 V 3.0 V



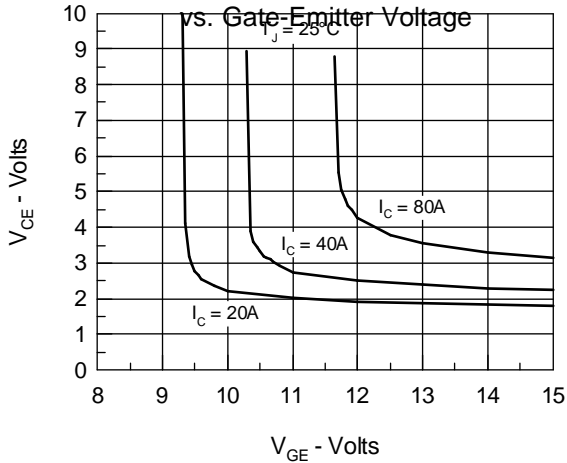
**Fig. 1 Saturation Characteristics**



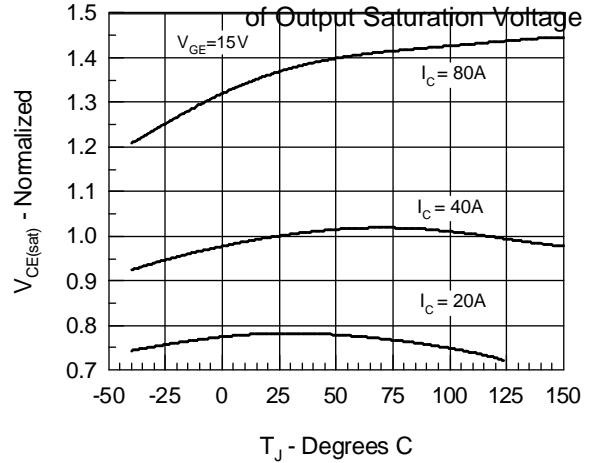
**Fig. 2 Output Characteristics**



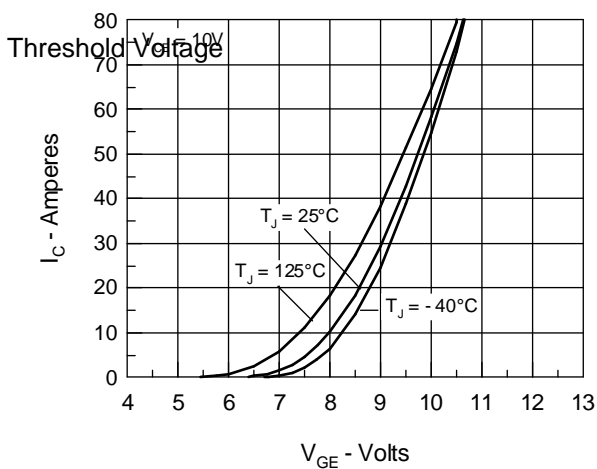
**Fig. 3 Collector-Emitter Voltage vs. Gate-Emitter Voltage**



**Fig. 4 Temperature Dependence of Output Saturation Voltage**



**Fig. 5 Input Admittance**



**Fig. 6 Temperature Dependence of Breakdown and**

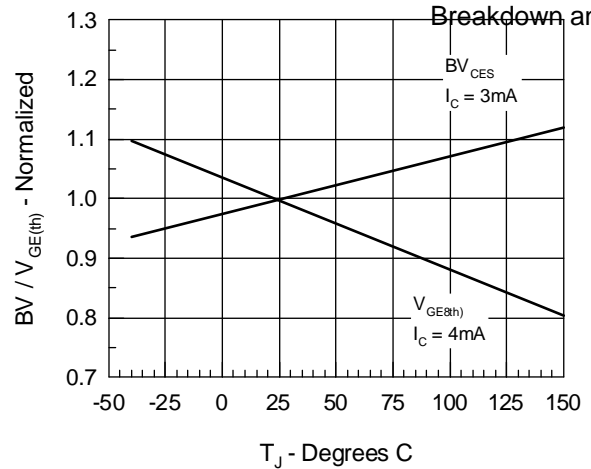


Fig.7 Turn-Off Energy per Pulse and Fall Time on Collector Current

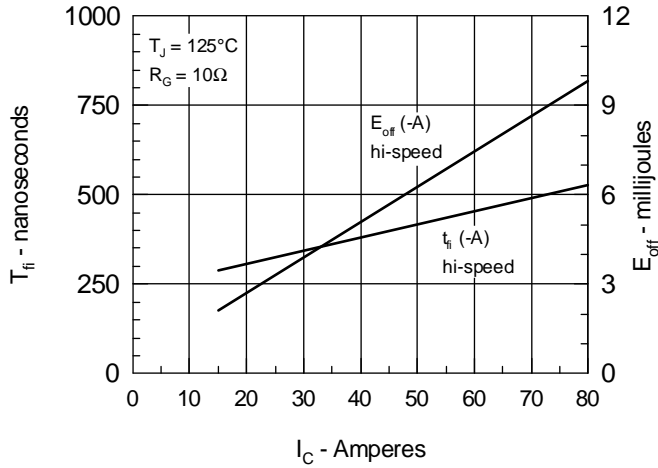


Fig.8 Dependence of Turn-Off Energy Per Pulse and Fall Time on R\_G

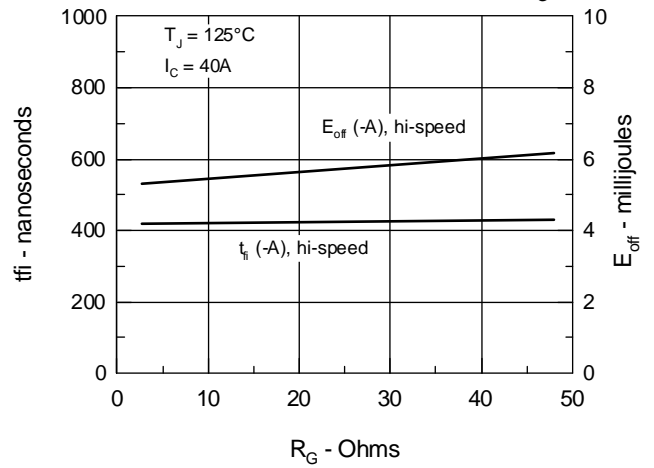


Fig.9 Gate Charge Characteristic Curve

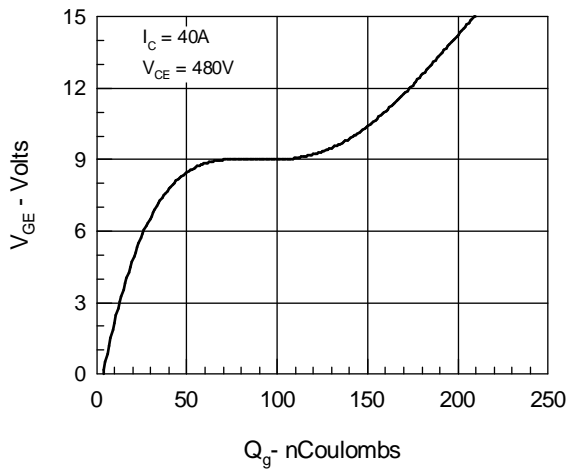


Fig.10 Turn-Off Safe Operating Area

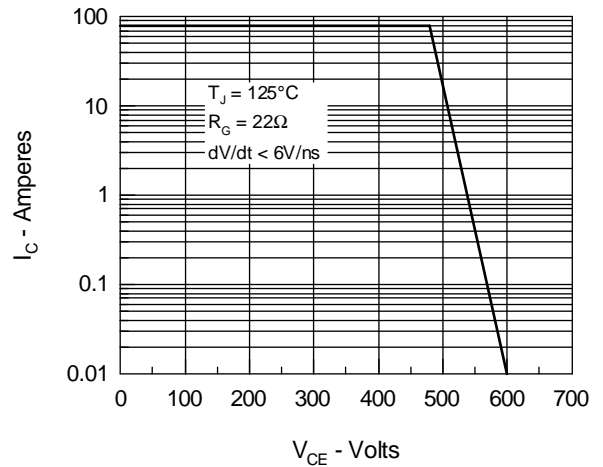
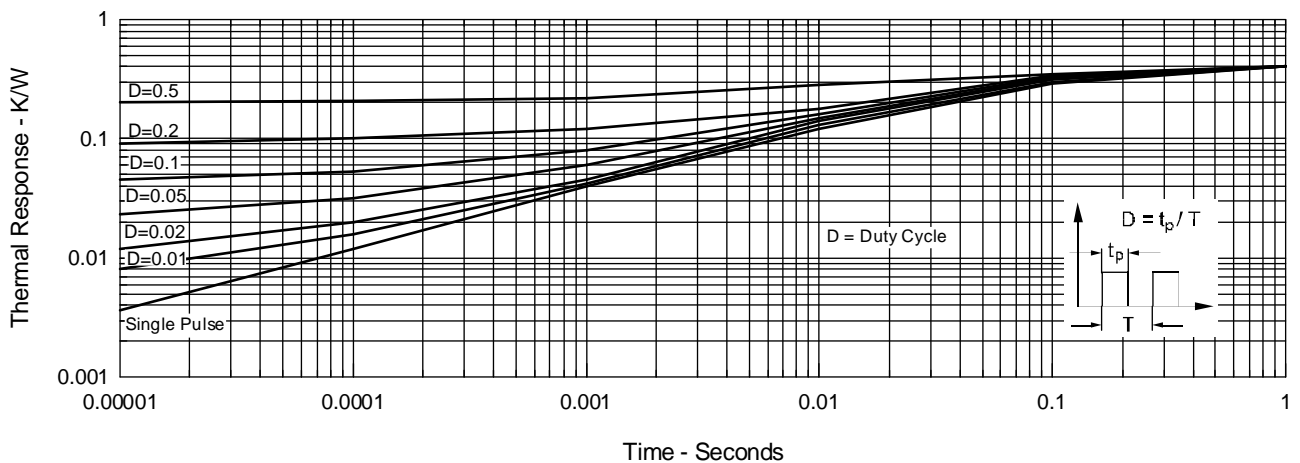


Fig.11 Transient Thermal Impedance





IXYS reserves the right to change limits, test conditions, and dimensions.

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